

1 Scope:

- 1.1 This specification is applicable to lead free and halogen free of ROHS directive for RAA series thick film chip resistors array.
- 1.2 This product is for automotive electronic application.
- 1.3 AEC-Q200 qualified , grade 1.

2 Explanation Of Part Numbers:



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Туре	Size	Number of Circuits	Terminal Type	Nom	ninal Resistance	Resistance Tolerance	Packaging (Refer to IE-SP-055)
Thick Film Chip Resistors Array	02(0402)	2:2 circuits	Difference	5% (3-Digit)	EX.10Ω=100 4.7Ω=4R7 JUMPER=000	D=± 0.5%	TH : 2 mm Pitch Carrier Tape 10000 pcs H2 : 2 mm Pitch Carrier Tape 20000 pcs H3 : 2 mm Pitch Carrier Tape 30000 pcs H4 : 2 mm Pitch Carrier Tape 40000 pcs
for automotive grade	03(0603)	8:8 circuits	D:Convex	0.5% 1% (4-Digit)	EX.10.2Ω=10R2 10KΩ=1002	J=± 1% J=± 5%	TP: 4 mm Pitch Carrier Tape 50000 pcsP2: 4 mm Pitch Carrier Tape 5000 pcsP3: 4 mm Pitch Carrier Tape 15000 pcsP3: 4 mm Pitch Carrier Tape 15000 pcsP4: 4 mm Pitch Carrier Tape 20000 pcs

3 General Specifications:

Туре	Rated Power	Max. Working	Max. Overload	T.C.R.		Resistance Range		Number of	Number Num of o Terminals Resis	Number of	JUMPER (0Ω) Rated Current	JUMPER (0Ω) Resistance Value
	at 70°C	Voltage	Voltage	(PP C)	D(±0.5%) E-24 、E-96	F(±1%) E-24 、E-96	J(±5%) E-24	Resistors		J (±5%)	J (±5%)	
RAA02-2D	1			±300		$1\Omega{\leq}R{<}10\Omega$	$1\Omega\!\leq\!R\!<\!10\Omega$				50mΩ	
(0402)	16 10	25V	50V	±200		$10\Omega{\le}R{\le}10M\Omega$	$10\Omega{\leq}R{\leq}10M\Omega$	4	2	1A	MAX.	
RAA03-2D (0603)	<u>1</u> 16 ^W	50V	100V	±200		$10\Omega{\leq}R{\leq}10M\Omega$	$1\Omega{\leq}R{\leq}10M\Omega$	4	2	1A	50mΩ MAX.	
RAA02-4D	1	25)/	50)/	±300		$1\Omega{\leq}R{<}10\Omega$	$1\Omega\!\leq\!R\!<\!10\Omega$	0	4	1.0	50mΩ	
(0402)	16	250	500	±200		$10\Omega{\leq}R{\leq}10M\Omega$	$10\Omega{\leq}R{\leq}10M\Omega$	8	4	1A	MAX.	
RAA03-4D (0603)	<u>1</u> 16	50V	100V	±200	22Ω≦R≦470KΩ	$1\Omega{\leq}R{\leq}10M\Omega$	$1\Omega{\leq}R{\leq}10M\Omega$	8	4	1A	50mΩ MAX.	
RAA02-8D (0402)	<u>1</u> 16	25V	50V	±250		$10\Omega{\leq}R{\leq}10M\Omega$	$1\Omega{\leq}R{\leq}10M\Omega$	16	8	1A	50mΩ MAX.	
Operating Temperature Range						-55℃ ~ +155	C					





3.1 Power Derating Curve:

Operating Temperature Range : - 55~155 ℃

For resistors operated in ambient temperatures above 70 $^\circ\!C$, power rating shall be derated in accordance with figure below $_\circ$



3.2 Voltage Rating:

Rated Voltage: The resistor shall have a DC continuous working voltage or a rms. AC continuous working voltage at commercial-line frequency and wave form corresponding to the power rating, as determined from the following:

$$E = \sqrt{R \times P}$$

E= Rated voltage (v) P= Power rating (w) R= Nominal resistance(Ω)

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DIM TYPE	L	W	н	L1	L2	Р	Q
RAA02-2D (0402)	1.00±0.10	1.00±0.10	0.30±0.05	0.15±0.10	0.25±0.10	(0.67)	0.33±0.10
RAA03-2D (0603)	1.60±0.15	1.60±0.15	0.45±0.10	0.30±0.15	0.30±0.15	(0.80)	0.60±0.10
RAA02-4D (0402)	2.00±0.10	1.00±0.10	0.40±0.10	0.20±0.10	0.25±0.10	(0.50)	0.30±0.10
RAA03-4D (0603)	3.20±0.20	1.60±0.15	0.50±0.10	0.30±0.15	0.30±0.15	(0.80)	0.50±0.10
RAA02-8D (0402)	4.00±0.20	1.60±0.10	0.40±0.10	0.30±0.15	0.30±0.10	(0.50)	0.25±0.10

5 Structure Graph:



1	Ceramic substrate	6	2nd Protective coating
2	Bottom inner electrode	7	Marking
3	Top inner electrode	8	Terminal inner electrode
4	Resistive layer	9	Ni plating
5	1st Protective coating	10	Sn plating

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6 Reliability Test:

ľ	tem		Conditions		Specificatio	ons
•				R	esistors	Jumper
		Put the	specimens in the chamber with temperature of	1. 0.5% ×	1%:	Refer to item 3.
High Te	emperature	room to	morature for 24+4br or more, and moasure of its	2.5% :	1.0 %	specifications
Exp	posure	resistan	ce variance rate		2.0%	
(St	orage)	resistari				
l		Experim	ent evidence: AEC-Q200			
		Put the	specimens in the High & low temperature test	$\triangle R=\pm 2.0$)%	Refer to item 3.
		chambe	r with temperature varies from -55 $^\circ\!\!\mathbb{C}$ to 125 $^\circ\!\!\mathbb{C}$ for			general
Tem	perature	15 minu	tes and total 1000 cycles. Then take them out to			specifications
Cy	ycling	stabilize	in room temperature for 24±4hr or more, and			
		measure	e of its resistance variance rate.			
			2.5 times rated voltage for 5 seconds and release	1 0 5%	1%:	Refer to item 3
		the load	for about 30 minutes, then measure its resistance	∧R-+	1.0%	General
Sho	ort Time	variance	erate.	2. 5% :	1.070	Specifications
Ov	reload	(Rated v	voltage refer to item 3. general specifications)	$\triangle R=\pm$	2.0%	
		Refer to	JIS-C5201-1 4.13			
		Solder t	he specimens on the test PCB and put them into the	1. 0.5%	• 1% :	Refer to item 3.
		constan	t temperature humidity chamber with $85\pm2\%$ and	$\Delta R = \pm 2$	2.0%	specifications
Diagon	h Llumidity	85±5%⊧	RH. I hen apply the test voltage that calculates based	∠. 5 ‰ · ∧R=+?	3.0%	opeenieuterie
Diaseu		to stabili	0% of fated power for 1000ms. Then take them out			
		measure	e of its resistance variance rate			
		Experim	ent evidence: AEC-Q200			
		Solder t	he specimens on the test PCB and Put them in the	1. 0.5%、	1%:	Refer to item 3.
		chambe	r with temperature of 125±3°C and load the voltage	∆R=±2	2.0%	general
		for 1000	hours. Then take them out to stabilize in room	2. 5%:		specifications
Ope	rational	tempera	ture for 24±4hr or more, and measure of its	$\triangle R=\pm3$	3.0%	
opo	Life	resistan	ce variance rate.			
		Note: If	ne input voltage shall refer to the power de-rating			
		cuive (ii	elerning to page 2, No.3. 1)			
		Experim	ent evidence: AEC-Q200			
		The spe	cimens are fully immersed into the Pb-free solder	∆R%=±1	.0%	Refer to item 3.
		pot, ther	n take them out to stabilize for 1 hour or more and			general
Rocia	stance to	measure	e of its resistance variance rate.			specifications
Solde	ring Heat	Temp of	f solder pot : 260±5°C			
00100	ingrioat	Solderin	ig duration : 10±1sec.			
		Evnorim	ant avidance AFC 0200			
		Experim Put the	specimens on the test fixture and two (2) discharges	^ R_+3 0	10/	Refer to item 3
		(2KV) D(c) shall be applied to each PUT one (1) with a	$\Delta N = \pm 3.0$	770	general
		positive	polarity and one (1) with a negative polarity.			specifications
		Afterwa	rds, the specimens stabilize for 30min or more and			
F	=90	measure	e of its resistance variance rate. The test is			
		perform	ed with direct contact and regular discharge mode.			
		The resi	istor and capacitor used on the spearhead is 2000Ω			
		and 150	pr respectively.			
		Experim	ent evidence AEC-Q200			
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ltom	Conditions	Specifications		
Item			Jumper	
Solderability	Test method: Test item 1 (solder pot test): Method B Precondition: The specimens are subjected to 155° C dry bake for 4hrs±15min. The specimens are immersed into the flux first, then fully immersed into the solder pot, at a temperature of $235\pm 5^{\circ}$ C for 5+0/-0.5 sec. Then rinse with water and observe the soldering coverage under the microscope. Test item 2 (Leaching test): Method D The specimens are immersed into the flux first, then fully immersed into the solder pot, at a temperature of $260\pm5^{\circ}$ C for 30+0/-0.5 sec. Then rinse with water and observe the soldering coverage under the microscope. Experiment evidence AEC-Q200	1.Soldering coverage ov 2.At the edge of terminal underneath (e.g. white c not expose.	er 95% I, the object eramic) shall	
Electrical Characterization	TCR(ppm / °C) = $\frac{(R2-R1)}{R1(T2-T1)} \times 10^{6}$ R1: Resistance at room temperature (Ω) R2: Resistance at -55°C or +125°C (Ω) T1: Room temperature (°C) T2: Temperature -55°C or +125°C Experiment evidence: AEC-Q200	Refer to item 3. general specifications	NA	
Board Flex (Bending Test)	Solder the specimens on the test PCB and put the PCBA onto the Bending Tester. Add force at the central part of PCB, and the duration of the applied forces shall be 60 (+ 5) Sec. Measure of its resistance variance rate in load. Bending depth (D)=5mm Experiment evidence: AEC-Q200	△R=±1.0% No mechanical damage, side end or chip crack.	Refer to item 3. general specifications peeling off of	

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- 9 Technical application notes: (This is for recommendation, please customer perform adjustment according to actual application)
 - 9.1 Recommend Soldering Method:
 - 9.1.1 Lead Free IR-Reflow Soldering Profile (MEET J-STD-020D)



Remark: The peak temperature of soldering heat is 260 +5/-0 $\,\,^\circ\!\mathrm{C}\,$ for 10 seconds

9.1.2 Soldering Iron: temperature 350 $^\circ\!\mathrm{C}\pm10\,^\circ\!\mathrm{C}\,$, dwell time shall be less than 3 sec.

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9.2 Recommend Land Pattern Design (For Reflow Soldering) :

When a component is soldered, the resistance after soldering changes slightly depending on the size of the soldering area and the amount of soldering. When designing a circuit, it is necessary to consider the effect of a decrease or increase in its resistance.



DIM TYPE	А	В	Р	Q1	Q2
RAA02-2D	0.50	2.00	0.67	0.33	0.34
RAA03-2D	1.00	2.60	0.80	0.40	0.40
RAA02-4D	0.50	2.00	0.50	0.28	0.22
RAA03-4D	1.00	2.60	0.80	0.40	0.40
RAA02-8D	1.00	2.60	0.50	0.25	0.25

9.3 Automobile Electronic Application:

This specification is for automobile electronic use. RALEC will take no responsibility if any damage, cost or loss occurs when the product has been used in any special circumstances.

- (a) Information $\$ entertainment $\$ navigation $\$ audio control units.
- (b) Comfortable door, window, seat control unit.
- (c) Internal lighting control unit.

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9.4 Environment Precautions:

If consumer intends to use our company product in special environment or condition (including but not limited to those mentioned below), then will need to make individual recognition of product features and reliability accordingly.

- (a) Used in high temperature and humidity environment
- (b) Exposed to sea breeze or other corrosive gas, such as Cl2 ${\scriptstyle \times}$ H2S ${\scriptstyle \vee}$ NH3 ${\scriptstyle \vee}$ SO2 and NO2.
- (c) Used in non-verified liquids including water, oil, chemical and organic solvents.
- (d) Using non-verified resin or other coating material to seal or coat our Company product.
- (e) After soldering, it is necessary to use water-soluble detergents to clean residual solder fluxes, even though no-clean fluxes are recommended.

9.5 Momentary Overload Precautions:

The product might be out of function when momentary overloaded. Please make sure to avoid momentary overloading while using and preserving •

9.6 Operation and Processing Precautions:

- (a) Avoid damage to the edge of resistor and protective layer caused by mechanical stress.
- (b) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
- (c) Make sure the power rating is under the limit when using the resistor. When power rating is over the limit, the resister will be overloaded. There might be machinery damage due to the climbing temperature
- (d) If the resister will be exposed under massive impact load (shock wave) in a short period of time, the working environment must be set up well before use.
- (e) Please make evaluation and confirmation when the product is well used in your company and have a through consideration of its fail-safe design to ensure the system safety.

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10 Storage and transportation requirement:

- 10.1 The temperature condition must be controlled at 25±5℃, the R.H. must be controlled at 60±15%. The stock can maintain quality level in two years.
- 10.2 Please avoid the mentioned harsh environment below when storing to ensure product performance and its' weldability. Places exposed to sea breeze or other corrosive gas, such as Cl2 < H2S < NH3 < SO2 and NO2.
- 10.3 When the product is moved and stored, please ensure the correct orientation of the box. Do not drop or squeeze the box. Otherwise, the electrode or the body of the product may be damaged.

11 The carton packaged for electronic-information products is made by the symbol as follows: (For china)



12 Attachments:

12.1 Document Revise Record Paper

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